

CLP DAY: PIXEurope Connect - Industry Ecosystem Building Day

May 21, 2026
09:30 to 18:00
Torre Glories, Barcelona

The Corporate Liaison Program (CLP) Day is a periodic meeting where ICFOnians, representatives of international platforms, multinational corporations, local business representatives and researchers of other institutions have the opportunity to interact with experts from around the world in a particular sector to review the latest advances in photonic technologies while focusing on the generation of joint research projects.

In the context of the PIXEurope Pilot Line - coordinated by ICFO and co-funded by the Chips Joint Undertaking and participating Member States, this year's CLP Day will be substituted by PIXEurope Connect - Industry Ecosystem Building Day, which will bring together end-users technology providers, industry leaders and policymakers around this integrated photonic Pan-European initiative.

PIXEurope is co-funded by the Chips Joint Undertaking and national funding authorities of the Participating States: Austria, Belgium, Finland, France, Ireland, Italy, The Netherlands, Poland, Portugal, Spain, United Kingdom.